


Recordation Form Cover Sheet PATENTS ONLY	
Attorney Docket No.: <u>7989P003</u>	
To the Director of the United States Patent and Trademark Office. Please record the attached original documents or copy thereof.	
1. Name of conveying party(ies): Shu Yuan and Xuejun Kang	2. Name and address of receiving party(ies): Name: <u>Tinggi Technologies Pte Limited</u>
Additional name(s) of conveying party(ies) attached? <input checked="" type="checkbox"/> No <input type="checkbox"/> Yes	Internal Address: _____
3. Nature of Conveyance <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other:	Street Address: <u>83 Science Park Drive, #03-01/02, The Curie</u>
Execution Date(s): <u>05.11.2005 and 05.12.2005</u>	City: <u>Singapore</u> State/Provence: _____ Zip: <u>118258</u>
4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: _____	Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
A. Patent Application No.(s): <u>10/593,107</u>	B. Patent No.(s): _____
Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: <input type="text" value="1"/>
Name: <u>Blakely, Sokoloff, Taylor & Zafman LLP</u>	7. Total Fee (37 CFR 3.41).....\$ <u>40.00</u>
Internal Address: _____	<input type="checkbox"/> Enclosed
Street Address: <u>1279 Oakmead Parkway</u>	<input checked="" type="checkbox"/> Authorized to be charged to deposit account
<u>Sunnyvale, California 94085-4040</u>	8. Deposit Account Number:
	<u>02-2666</u>
	(Attach duplicate copy of this page if paying by deposit account)
DO NOT USE THIS SPACE	
9. Statement and signature. <i>To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.</i>	
<u>Lester J. Vincent, Reg. No. 31.460</u> Name of Person Signing	 Signature
	<u>June 11, 2010</u> Date
Total number of pages including cover sheet, attachments, and documents: <input type="text" value="5"/>	

Mail documents to be recorded with required cover sheet information to:
Mail Stop Assignment Recordation Services
Director of the United States Patent and Trademark Office
P.O. Box 1450
Alexandria, Virginia 22313-1450

Based on Form PTO-1595 as modified by BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP on 05/09/03

ASSIGNMENT

WHEREAS,

YUAN, Shu, residing at 8 Jalan Pakis Singapore 678598, a citizen of the Commonwealth of Australia and a resident of the Republic of Singapore; AND
KANG, Xuejun, residing at Block 509 West Coast Drive #11-277, Singapore 120509, a citizen of the People's Republic of China and a permanent resident of Republic of Singapore

(collectively the "Assignors")

are the inventors of the inventions in:

1. Fabrication of Semiconductor Device; and
2. Fabrication of Reflective Layer on Semiconductor Light Emitting Diodes

(collectively "the Inventions");

AND WHEREAS

TINGGI TECHNOLOGIES PTE LTD, is a company incorporated in the Republic of Singapore, having a place of business at 83 Science Park Drive #03-01/02, The Curie, Singapore 118258 ("Assignee");

AND WHEREAS the Inventors prepared the Inventions in the course of their employment by the Assignee such that the Assignee is the owner thereof and in consequence the Assignee has filed applications for patent as set-out in the Schedule hereto;

AND the Assignee is desirous of obtaining a confirmatory assignment of all rights, title and interest in, to and under the Inventions;

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the ASSIGNORS, have sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns:

- (a) their right, title and interest in, to and under the Inventions;
- (b) all Patents which may be granted thereon and all reissues and extensions thereof;

- (c) all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said Inventions in any country, countries or regions;
- (d) the right to file such applications under the International Convention for the Protection of Industrial Property, the TRIPS Agreement, the Patent Co-operation Treaty, or any other international agreement or the domestic laws of the country or region in which any such application is filed, as may be applicable; and
- (e) all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for the Inventions in any country, countries, region or regions and all extensions, renewals and reissues thereof;

And the ASSIGNORS hereby covenant and agree that:

- (a) they have the full right to convey the entire interest herein assigned, and that they have not executed, and will not execute, any agreement in conflict herewith; and
- (b) they will execute all documents including but not limited to divisional, continuing, reissue and foreign applications as are reasonably required by the said ASSIGNEE or its successors, legal representatives and assigns, to enable the ASSIGNEE to file applications, prosecute those applications to grant, and to obtain proper protection for said Inventions in all countries and regions;

And the ASSIGNEE hereby accepts the assignment of the Inventions and all the stated rights, from the ASSIGNORS


SCHEDULE

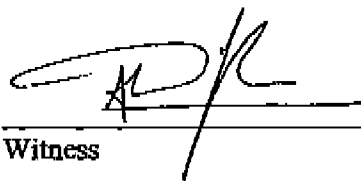
Singapore	200401424-7	15 March 2004	Fabrication of Semiconductor Device
-----------	-------------	---------------	-------------------------------------

✓ PCT	PCT/SG2005/000061	1 March 2005	Fabrication of Semiconductor Device
Malaysia	YTBA	8 March 2005	Fabrication of Semiconductor Device
Taiwan	94106604	4 March 2005	Fabrication of Semiconductor Device
Singapore	200401964-2	7 April 2004	Fabrication of Reflective Layer on Semiconductor Light Emitting Diodes
✓ PCT	PCT/SG2005/000062	1 March 2005	Fabrication of Reflective Layer on Semiconductor Light Emitting Diodes
Malaysia	YTBA	8 March 2005	Fabrication of Reflective Layer on Semiconductor Light Emitting Diodes
Taiwan	94106602	4 March 2005	Fabrication of Reflective Layer on Semiconductor Light Emitting Diodes

In witness whereof, the Inventors have affixed their signature.

11 May 2005
Date

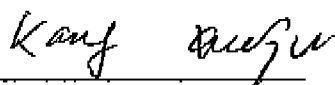

YUAN, SHU

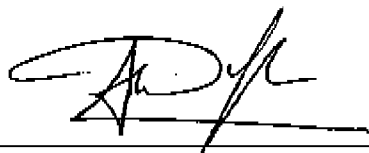

Witness

Witness Name: Alicia Wee

Witness Address: Blk 606 Ang Mo Kio Ave 1
#07-2759 S(560606)

12 May 2005
Date


KANG, XUEJUN


Witness Alicia Wee

Witness Name:

Witness Address: Blk 606 Ang Mo Kio
#07-2759 S(560606)

Executed by the ASSIGNEE
in accordance with the laws of the
Republic of Singapore

)
)
)

Name:
Position: